

DT07 Rec'd PCT/PTO 07 MAR 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE  
(Case No. 05-040)

PATENT

the Application of:

Heylbroeck et al.

Serial No.: 10/521,915

Filing Date: January 20, 2005

For: In-Line Demetallization Process for  
Flexible Metallized Substrates

Before the Examiner:

Group Art Unit:

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

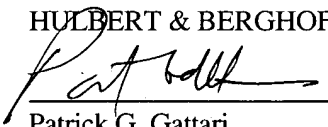
**TRANSMITTAL LETTER**

In regard to the above identified application:

1. We are transmitting herewith the attached:
2.
  - a. Power of Attorney by Assignee of Entire Interest;
  - b. Copy of Assignment submitted on January 20, 2005;
  - c. Postcard.
3. No Fee is required.
4. Please charge any additional fees or credit overpayment to Deposit Account No.13-2490.

Respectfully submitted,

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CERTIFICATE OF MAILING UNDER 37 CFR § 1.8: The undersigned hereby certifies that this Transmittal Letter and the papers, as described in paragraph 1 hereinabove, are being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231 on this End day of March 2005.

BEST AVAILABLE COPY